

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



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N-Channel Power MOSFET

500V, 4A, 2.7Ω

FEATURES

- 100% UIS and Rg tested
- · Advanced planar process
- Compliant to RoHS Directive 2011/65/EU and in accordance to WEEE 2002/96/EC
- Halogen-free according to IEC 61249-2-21

KEY PERFORMANCE PARAMETERS				
PARAMETER VALUE UNIT				
V_{DS}	500	V		
R _{DS(on)} (max)	2.7	Ω		
Q_g	12	nC		

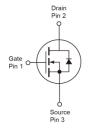
APPLICATIONS

- AC/DC LED Lighting
- Power Supply
- Charger









Notes: MSL 3 (Moisture Sensitivity Level) per J-STD-020

ABSOLUTE MAXIMUM RATINGS (T _A = 25°C unless otherwise noted)				
PARAMETER		SYMBOL	Limit	UNIT
Drain-Source Voltage		V _{DS}	500	V
Gate-Source Voltage		V _{GS}	±20	V
Continuous Drain Current (Note 1)	$T_C = 25^{\circ}C$		4	^
	$T_C = 100$ °C	I _D	2.5	Α
Pulsed Drain Current (Note 2)		I _{DM}	16	Α
Total Power Dissipation @ $T_C = 25^{\circ}C$		P _{DTOT}	83	W
Single Pulse Avalanche Energy (Note 3)	E _{AS}	78.4	mJ
Single Pulse Avalanche Current (Note 3	3)	I _{AS}	2.8	Α
Operating Junction and Storage Tem	perature Range	T _J , T _{STG}	- 55 to +150	°C

THERMAL PERFORMANCE				
PARAMETER	SYMBOL	Limit	TINU	
Junction to Case Thermal Resistance	R _{eJC}	1.5	°C/W	
Junction to Ambient Thermal Resistance	R _{eJA}	62	°C/W	

Thermal Performance Note: $R_{\Theta JA}$ is the sum of the junction-to-case and case-to-ambient thermal resistances. The case-thermal reference is defined at the solder mounting surface of the drain pins. $R_{\Theta JA}$ is guaranteed by design while $R_{\Theta CA}$ is determined by the user's board design. $R_{\Theta JA}$ shown below for single device operation on FR-4 PCB in still air.

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ELECTRICAL SPECIFICAT	FIONS (T _A = 25°C unles	ss otherwise no	oted)	1	1	
PARAMETER	CONDITIONS	SYMBOL	MIN	TYP	MAX	UNIT
Static						
Drain-Source Breakdown Voltage	$V_{GS} = 0V, I_D = 250\mu A$	BV _{DSS}	500			٧
Gate Threshold Voltage	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	$V_{GS(TH)}$	2	2.2	3	V
Gate Body Leakage	$V_{GS} = \pm 20V$, $V_{DS} = 0V$	I _{GSS}			±100	nA
Zero Gate Voltage Drain Current	$V_{DS} = 500V, V_{GS} = 0V$	I _{DSS}			1	μΑ
Drain-Source On-State Resistance (Note 4)	$V_{GS} = 10V, I_D = 1.7A$	R _{DS(on)}		2.4	2.7	Ω
Dynamic (Note 5)		1		l	l	I
Total Gate Charge		Q_g		12		
Gate-Source Charge	$V_{DS} = 400V, I_D = 3.4A,$ $V_{GS} = 10V$	Q_{gs}		2.2		nC
Gate-Drain Charge		Q_{gd}		4.4		
Input Capacitance	$V_{DS} = 50V, V_{GS} = 0V,$ f = 1.0MHz	C _{iss}		453		
Output Capacitance		C _{oss}		27		pF
Reverse Transfer Capacitance	1 = 1.0IVIM2	C _{rss}		1		
Gate Resistance	f = 1.0MHz	R_g		2.6	5.2	Ω
Switching (Note 6)						
Turn-On Delay Time		t _{d(on)}		5.4		
Turn-On Rise Time	$V_{DD} = 250 V, \; R_G = 5 \Omega, \\ I_D = 3.4 A, \; V_{GS} = 10 V$	t _r		18.4		
Turn-Off Delay Time		t _{d(off)}		12.4		ns
Turn-Off Fall Time		t _f		19.6		
Source-Drain Diode						
Forward Voltage (Note 4)	I _S = 3.4A, V _{GS} = 0V	V_{SD}			1.3	V
Reverse Recovery Time	I _S = 3.4A	t _{rr}		233		ns
Reverse Recovery Charge	$dI_F/dt = 100A/\mu s$	Q_{rr}		0.84		μC

Notes:

- 1. Current limited by package
- 2. Pulse width limited by the maximum junction temperature
- 3. L = 20mH, $I_{AS} = 2.8A$, $V_{DD} = 50V$, $R_G = 25\Omega$, Starting $T_J = 25^{\circ}C$
- 4. Pulse test: PW ≤ 300μs, duty cycle ≤ 2%
- 5. For DESIGN AID ONLY, not subject to production testing.
- 6. Switching time is essentially independent of operating temperature.

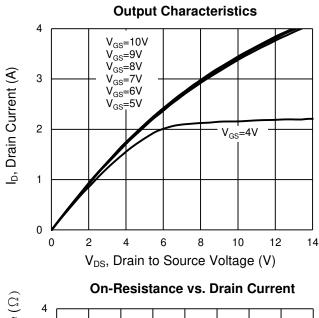
ORDERING INFORMATION

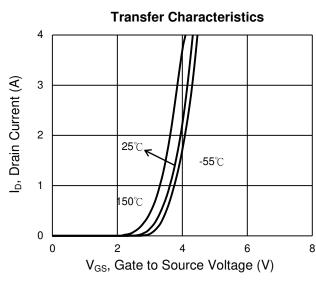
PART NO.	PACKAGE	PACKING
TSM4NC50CP ROG	TO-252 (DPAK)	2.500pcs / 13" Reel

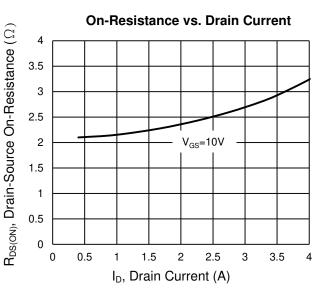


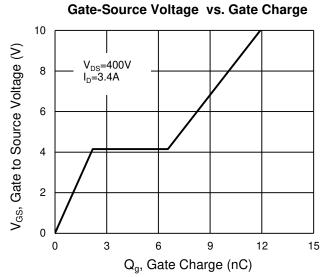
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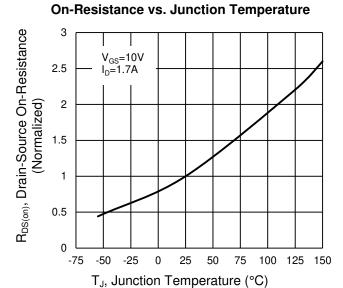
 $(T_A = 25^{\circ}C \text{ unless otherwise noted})$

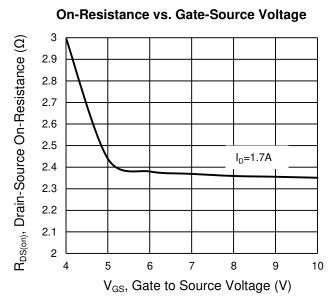












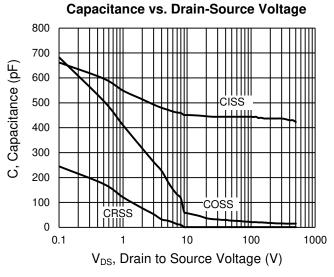
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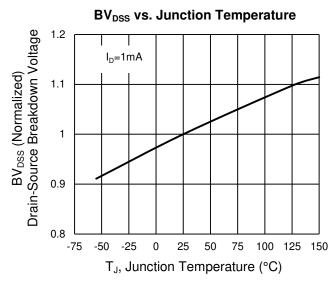
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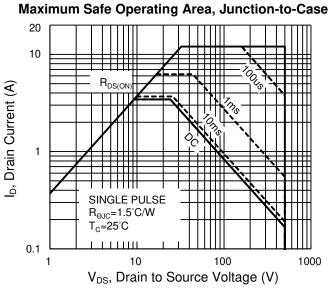


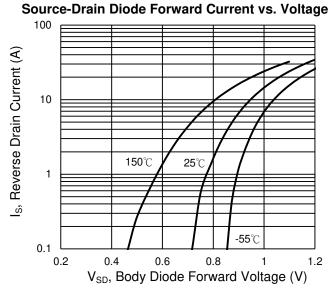
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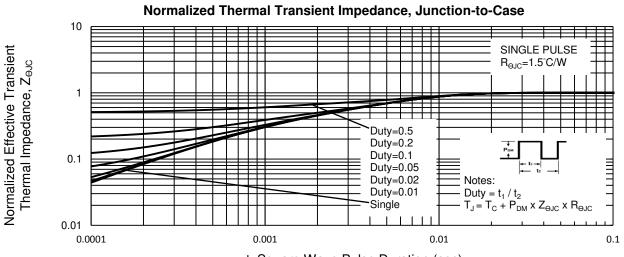
 $(T_A = 25^{\circ}C \text{ unless otherwise noted})$









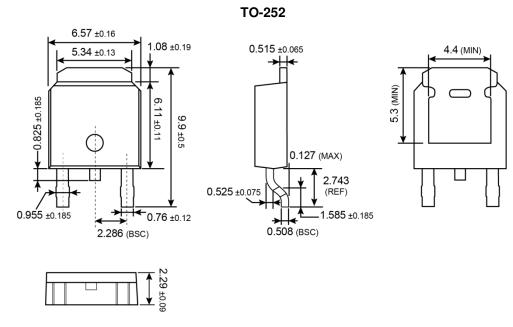


t, Square Wave Pulse Duration (sec)

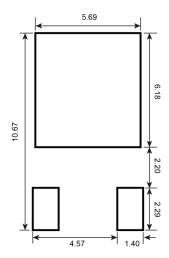




PACKAGE OUTLINE DIMENSIONS (Unit: Millimeters)



SUGGESTED PAD LAYOUT (Unit: Millimeters)



Z =Dec

5

MARKING DIAGRAM



Y = Year Code

M = Month Code

O =Jan **P** =Feb **Q** =Mar **R** =Apr

X =Oct

 $S = May \quad T = Jun \quad U = Jul \quad V = Aug$

Y =Nov

L = Lot Code (1~9, A~Z)

W =Sep



Taiwan Semiconductor

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